

# RB151G THRU RB157G

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# RB151G THRU RB157G

## 1.5A Glass Passivated Single-Phase Bridge Rectifiers-50-1000V

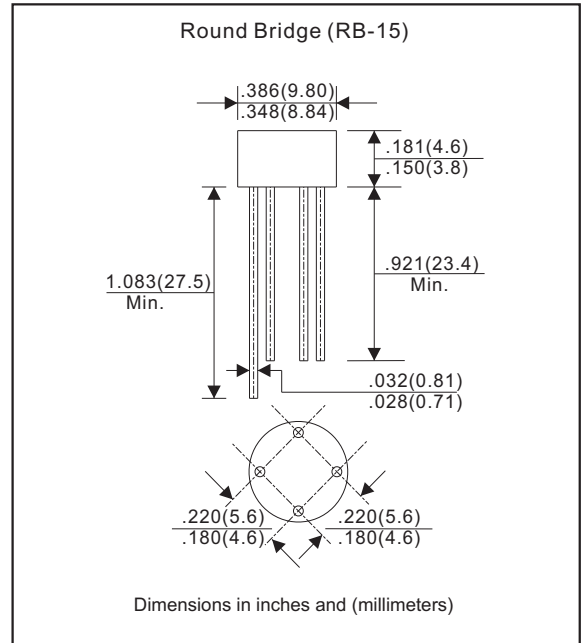
### Features

- Surge overload rating 40 amperes peak
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique results in expensive product
- Lead-free parts for green partner, meet RoHS requirements
- Suffix "-H" indicates Halogen-free parts, ex. RB151G-H

### Mechanical data

- Case: Potted plastic round body RB-15
- Epoxy: UL94-V0 rated flame retardant
- Terminals: Solderable per MIL-STD-750 Method 2026
- Polarity: As marked
- Mounting Position: Any

### Package outline



### Maximum ratings and Electrical characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	$I_o$			1.5	A
Forward surge current	8.3ms single half sine-wave (JEDEC methode)	$I_{FSM}$			40	A
Reverse current	$V_R = V_{RRM} T_J = 25^{\circ}\text{C}$	$I_R$			10.0	uA
	$V_R = V_{RRM} T_J = 100^{\circ}\text{C}$				1000	
$I^2t$ Rating for fusing	$t < 8.3$ ms	$I^2t$			6.64	$\text{A}^2\text{s}$
Storage temperature		$T_{STG}$	-65		+175	$^{\circ}\text{C}$

SYMBOLS	$V_{RRM}^{*1}$ (V)	$V_{RMS}^{*2}$ (V)	$V_R^{*3}$ (V)	$V_F^{*4}$ (V)	Operating temperature $T_J$ , ( $^{\circ}\text{C}$ )
RB151G	50	35	50	1.10	-55 to +150
RB152G	100	70	100		
RB153G	200	140	200		
RB154G	400	280	400		
RB155G	600	420	600		
RB156G	800	560	800		
RB157G	1000	700	1000		

- \*1 Repetitive peak reverse voltage
- \*2 RMS voltage
- \*3 Continuous reverse voltage
- \*4 Maximum forward voltage per element @  $I_F=1.5\text{A}$

## Rating and characteristic curves (RB151G THRU RB157G)

Fig. 1 - Forward Current Derating Curve

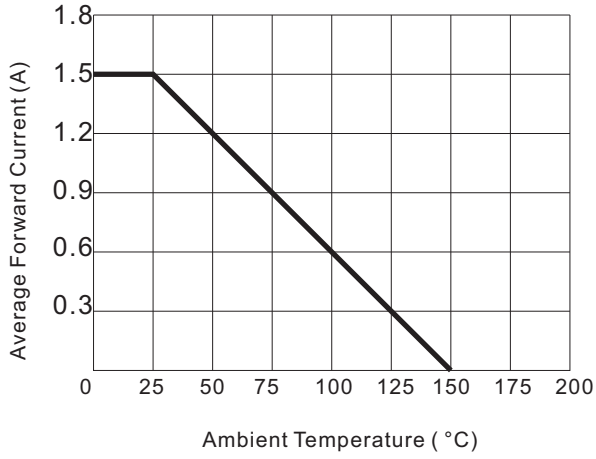


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

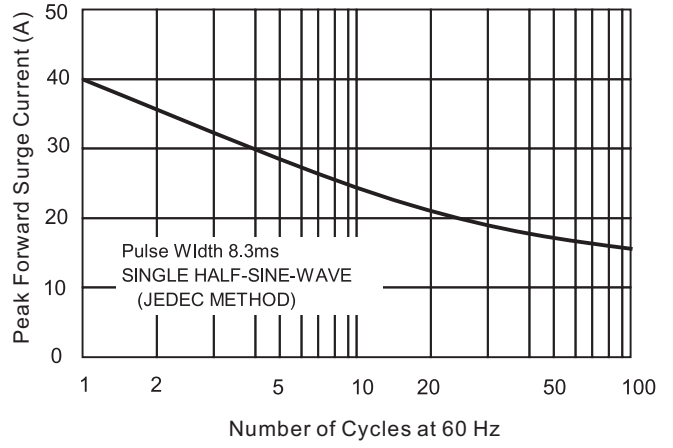


Fig. 3 - Typical Instantaneous Forward Characteristics (Per Leg)

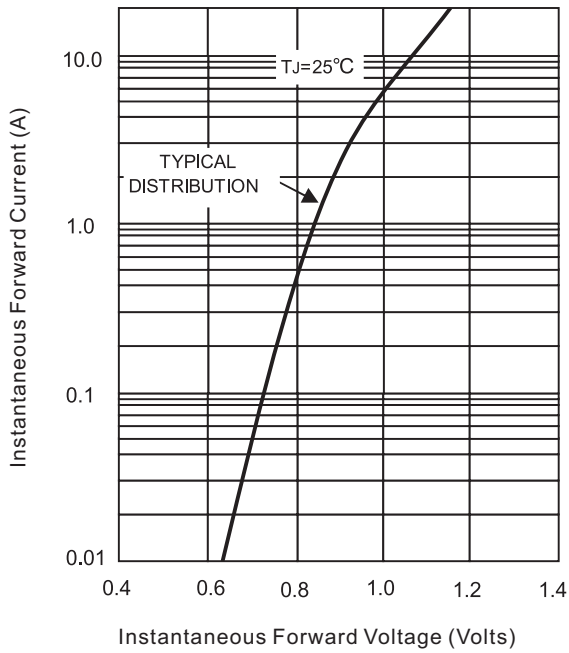
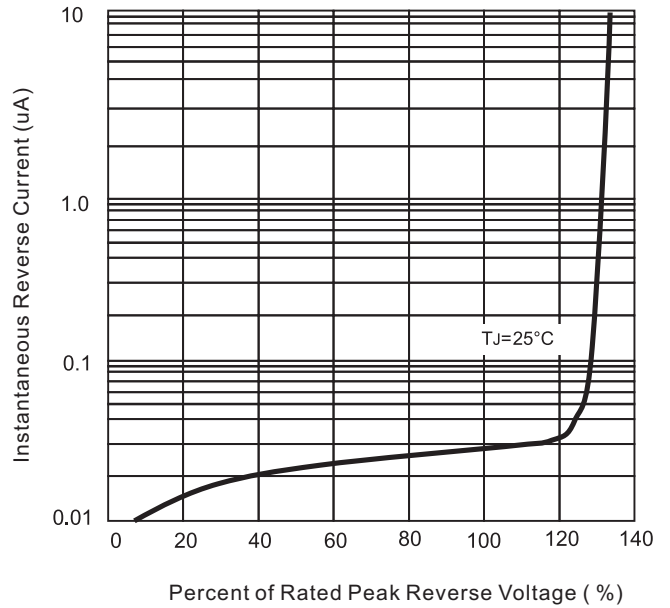

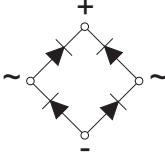


Fig. 4 - Typical Reverse Characteristics (Per Leg)



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## Pinning information

Simplified outline	Symbol
	

## Marking

Type number	Marking code
RB151G	RB151G
RB152G	RB152G
RB153G	RB153G
RB154G	RB154G
RB155G	RB155G
RB156G	RB156G
RB157G	RB157G

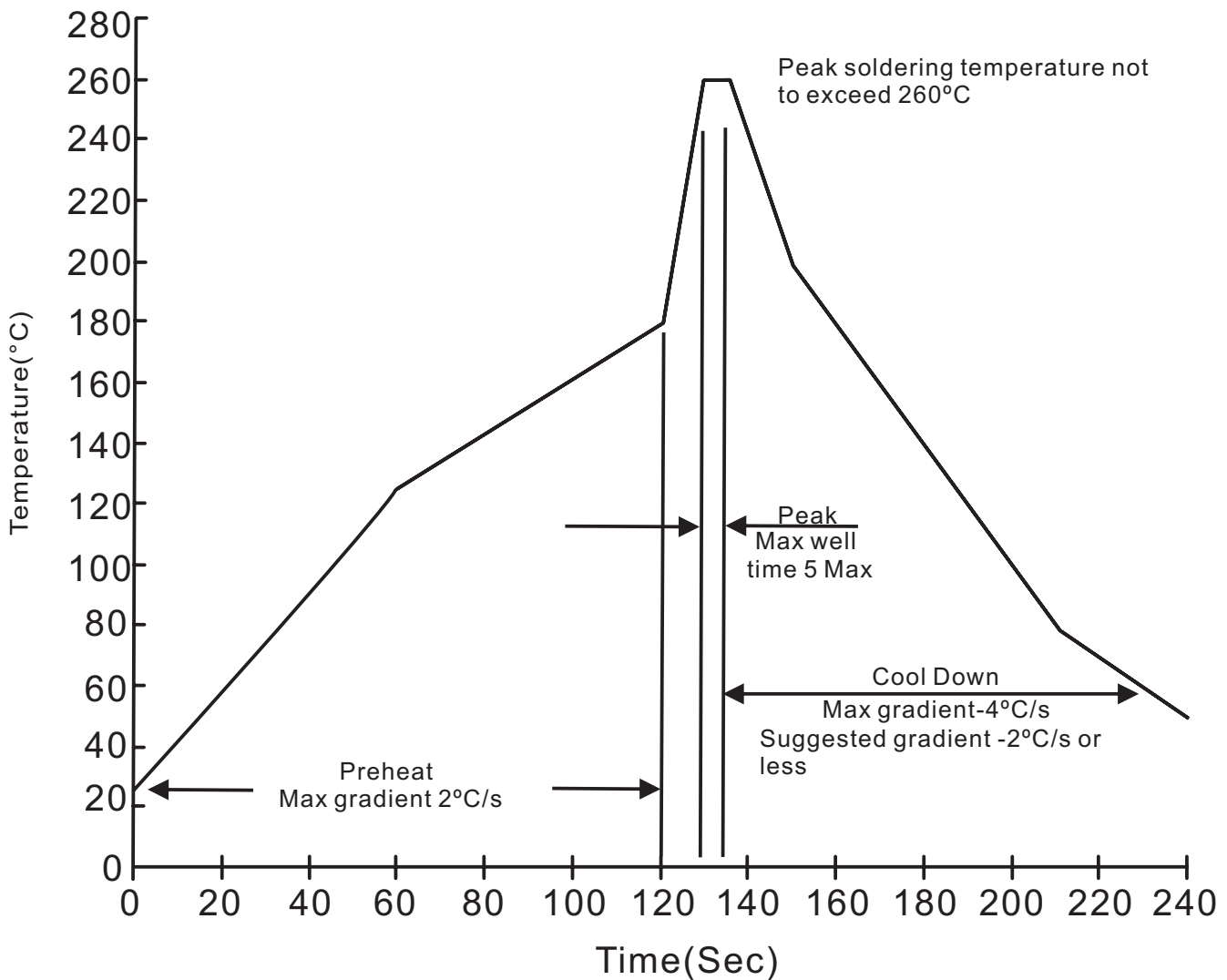
## Bulk packing

PACKAGE	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
RB-15	1,000	230*230*49	490*240*310	10,000	13.0

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## Suggested thermal profiles for soldering processes

### 1. Lead free temperature profile wave-soldering



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## High reliability test capabilities

Item Test	Conditions	Reference
1. Solder Resistance	at 260±5°C for 10±2sec. immerse body into solder 1/16"±1/32"	MIL-STD-750D METHOD-2031
2. Solderability	at 245±5°C for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	V <sub>R</sub> =80% rate at T <sub>J</sub> =150°C for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at T <sub>A</sub> =25°C for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	T <sub>A</sub> = 25°C, I <sub>F</sub> = I <sub>O</sub> On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	15P <sub>SIG</sub> at T <sub>A</sub> =121°C for 4 hrs.	JESD22-A102
7. Temperature Cycling	-55°C to +125°C dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at T <sub>A</sub> =85°C, RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at 175°C for 1000 hrs.	MIL-STD-750D METHOD-1031